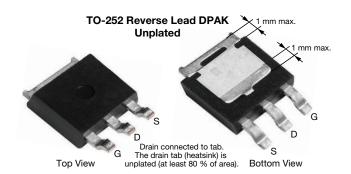


Vishay Siliconix

# Automotive N-Channel 100 V (D-S) 175 °C MOSFET



PRODUCT SUMMARY					
V <sub>DS</sub> (V)	100				
$R_{DS(on)}(\Omega)$ at $V_{GS} = 10 \text{ V}$	0.0087				
$R_{DS(on)}(\Omega)$ at $V_{GS} = 4.5 \text{ V}$	0.0106				
I <sub>D</sub> (A)	86				
Configuration	Single				
Package	TO-252 Reverse Lead DPAK				

#### **FEATURES**

- TrenchFET® power MOSFET
- Unplated drain tab (heatsink)
- Package with low thermal resistance
- AEC-Q101 qualified
- 100 % R<sub>g</sub> and UIS tested
- Material categorization: for definitions of compliance please see <a href="https://www.vishay.com/doc?99912">www.vishay.com/doc?99912</a>



G O	
N-Channel MOSFET	٥

ABSOLUTE MAXIMUM RATINGS (T <sub>C</sub> = 25 °C, unless otherwise noted)					
PARAMETER		SYMBOL	LIMIT	UNIT	
Drain-Source Voltage		$V_{DS}$	100	.,	
Gate-Source Voltage		$V_{GS}$	± 20	V	
Continuous Drain Current	T <sub>C</sub> = 25 °C	1	86		
	T <sub>C</sub> = 125 °C	l <sub>D</sub>	50		
Continuous Source Current (Diode conduction) <sup>a</sup>		I <sub>S</sub>	100	Α	
Pulsed Drain Current <sup>b</sup>		I <sub>DM</sub>	150		
Single Pulse Avalanche Current	L = 0.1 mH	I <sub>AS</sub>	45		
Single Pulse Avalanche Energy	L=0.1 IIIH	E <sub>AS</sub>	101	mJ	
Maximum Power Dissipation <sup>b</sup>	T <sub>C</sub> = 25 °C	- P <sub>D</sub>	136	W	
	T <sub>C</sub> = 125 °C		45	VV	
Operating Junction and Storage Temperature Range		T <sub>J</sub> , T <sub>stg</sub>	-55 to +175	°C	

THERMAL RESISTANCE RATINGS					
PARAMETER		SYMBOL	LIMIT	UNIT	
Junction-to-Ambient	PCB mount c	$R_{thJA}$	50	°C/W	
Junction-to-Case (Drain)		R <sub>thJC</sub>	1.1	C/VV	

### Notes

- a. Package limited.
- b. Pulse test; pulse width  $\leq$  300  $\mu$ s, duty cycle  $\leq$  2 %.
- c. When mounted on 1" square PCB (FR4 material).



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PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNIT	
Static					•			
Drain-Source Breakdown Voltage	V <sub>DS</sub>	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$		100	-	-		
Gate-Source Threshold Voltage	V <sub>GS(th)</sub>	V <sub>DS</sub> =	$V_{DS} = V_{GS}, I_D = 250 \mu A$		2.0	2.5	V	
Gate-Source Leakage	I <sub>GSS</sub>	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$		-	-	± 100	nA	
		V <sub>GS</sub> = 0 V	V <sub>DS</sub> = 100 V	-	-	1		
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	$V_{GS} = 0 V$	V <sub>DS</sub> = 100 V, T <sub>J</sub> = 125 °C	-	-	50	μΑ	
		V <sub>GS</sub> = 0 V	V <sub>DS</sub> = 100 V, T <sub>J</sub> = 175 °C	-	-	250		
On-State Drain Current <sup>a</sup>	I <sub>D(on)</sub>	V <sub>GS</sub> = 10 V	$V_{DS} \ge 5 V$	50	-	-	Α	
		V <sub>GS</sub> = 10 V	I <sub>D</sub> = 25 A	-	0.0072	0.0087	- Ω	
Drain Course On State Besistance 3	В	V <sub>GS</sub> = 4.5 V	I <sub>D</sub> = 20 A	-	0.0087	0.0106		
Drain-Source On-State Resistance <sup>a</sup>	R <sub>DS(on)</sub>	V <sub>GS</sub> = 10 V	I <sub>D</sub> = 25 A, T <sub>J</sub> = 125 °C	-	-	0.0144		
		V <sub>GS</sub> = 10 V	I <sub>D</sub> = 25 A, T <sub>J</sub> = 175 °C	-	-	0.0177		
Forward Transconductance b	9 <sub>fs</sub>	V <sub>DS</sub> = 15 V, I <sub>D</sub> = 25 A		-	80	=	S	
Dynamic <sup>b</sup>	•	•						
Input Capacitance	C <sub>iss</sub>			-	2550	3500		
Output Capacitance	C <sub>oss</sub>	$V_{GS} = 0 V$	V <sub>GS</sub> = 0 V V <sub>DS</sub> = 25 V, f = 1 MHz		1350	1900	рF	
Reverse Transfer Capacitance	C <sub>rss</sub>			-	101	140		
Total Gate Charge <sup>c</sup>	Qg			-	42	65		
Gate-Source Charge <sup>c</sup>	$Q_{gs}$	V <sub>GS</sub> = 10 V	$V_{DS} = 50 \text{ V}, I_{D} = 50 \text{ A}$	-	7	-	nC	
Gate-Drain Charge <sup>c</sup>	Q <sub>gd</sub>				8	=		
Gate Resistance	Rg	f = 1 MHz		1.4	2.9	4.4	Ω	
Turn-On Delay Time <sup>c</sup>	t <sub>d(on)</sub>	$V_{DD} = 50 \text{ V, } R_L = 1  \Omega$ $I_D \cong 50 \text{ A, } V_{GEN} = 10 \text{ V, } R_g = 1  \Omega$		-	12	20		
Rise Time <sup>c</sup>	t <sub>r</sub>			-	5	10		
Turn-Off Delay Time <sup>c</sup>	t <sub>d(off)</sub>			-	35	60	ns	
Fall Time <sup>c</sup>	t <sub>f</sub>			-	6	15		
Source-Drain Diode Ratings and Chara	acteristics <sup>b</sup>							
Pulsed Current <sup>a</sup>	I <sub>SM</sub>			-	-	150	Α	
Forward Voltage	$V_{SD}$	I <sub>F</sub> = 25 A, V <sub>GS</sub> = 0 V			0.88	1.5	V	

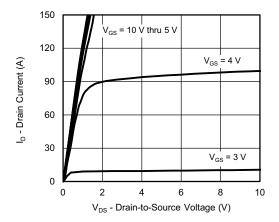
#### Notes

- a. Pulse test; pulse width  $\leq 300~\mu s,\,duty~cycle \leq 2~\%.$
- b. Guaranteed by design, not subject to production testing.
- c. Independent of operating temperature.

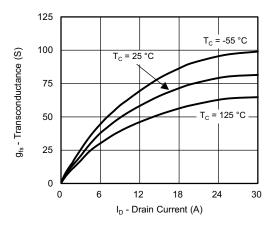
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



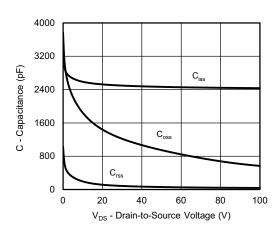
## **TYPICAL CHARACTERISTICS** (T<sub>A</sub> = 25 °C, unless otherwise noted)



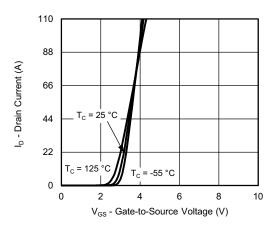
### **Output Characteristics**



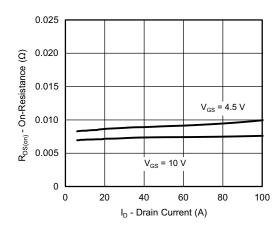
Transconductance



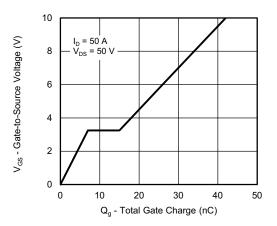
Capacitance



**Transfer Characteristics** 



On-Resistance vs. Drain Current

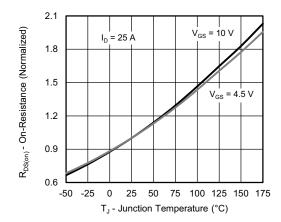


**Gate Charge** 

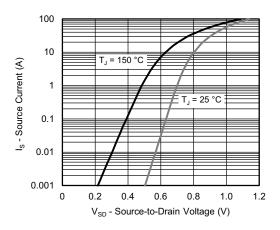
For technical questions, contact: automostechsu



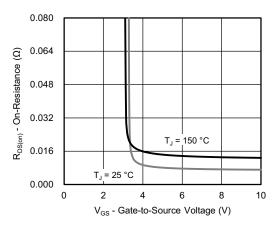
## **TYPICAL CHARACTERISTICS** (T<sub>A</sub> = 25 °C, unless otherwise noted)



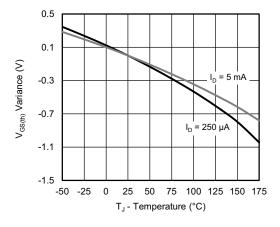
On-Resistance vs. Junction Temperature



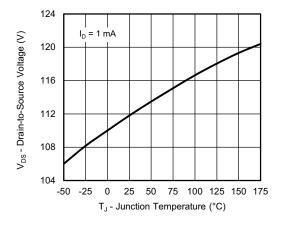
**Source Drain Diode Forward Voltage** 



On-Resistance vs. Gate-to-Source Voltage



**Threshold Voltage** 

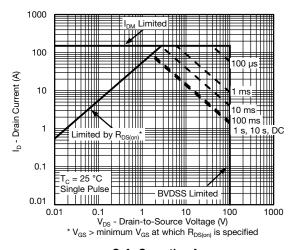


Drain Source Breakdown vs. Junction Temperature

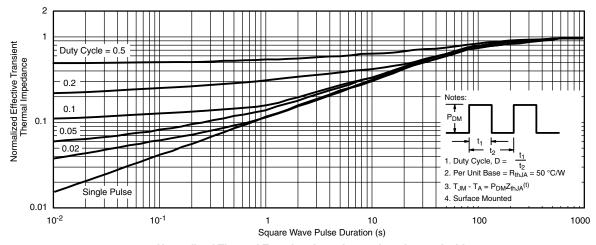
For technical questions, contact: automostech



## **THERMAL RATINGS** ( $T_A = 25$ °C, unless otherwise noted)



Safe Operating Area

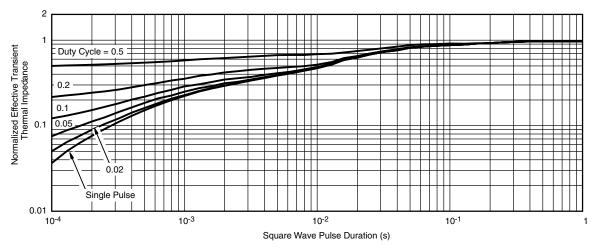


Normalized Thermal Transient Impedance, Junction-to-Ambient

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## THERMAL RATINGS (T<sub>A</sub> = 25 °C, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Case

#### Note

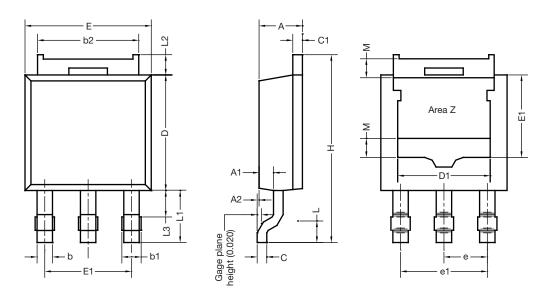
- The characteristics shown in the two graphs
  - Normalized Transient Thermal Impedance Junction-to-Ambient (25 °C)
  - Normalized Transient Thermal Impedance Junction-to-Case (25 °C)

are given for general guidelines only to enable the user to get a "ball park" indication of part capabilities. The data are extracted from single pulse transient thermal impedance characteristics which are developed from empirical measurements. The latter is valid for the part mounted on printed circuit board - FR4, size 1" x 1" x 0.062", double sided with 2 oz. copper, 100 % on both sides. The part capabilities can widely vary depending on actual application parameters and operating conditions.

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## **TO-252 Reverse Lead Case Outline**



#### Notes

- Dimension L3 for reference only
- Area Z: unplated area more than 80 % heatsink area and for partial plating part only

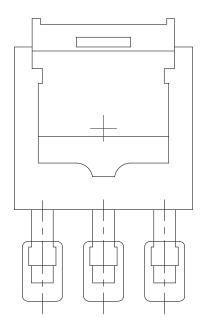
DIM.	MIL	LIMETERS	INCHES		
DIN.	MIN.	MAX.	MIN.	MAX.	
А	2.23	2.33	0.088	0.092	
A1	0.64	0.89	0.025	0.035	
A2	0.03	0.18	0.001	0.007	
b	0.71	0.88	0.028	0.035	
b1	0.76	1.14	0.030	0.045	
b2	5.23	5.44	0.206	0.214	
С	0.46	0.58	0.018	0.023	
C1	0.46	0.58	0.018	0.023	
D	5.97	6.22	0.235	0.245	
D1	4.49	5.00	0.177	0.197	
E	6.48	6.73	0.255	0.265	
E1	4.32	-	0.170	-	
е	2	.28 BSC	0.	090 BSC	
e1	4	.57 BSC	0.	180 BSC	
Н	9.65	10.41	0.380	0.410	
L	1.40	1.78	0.055	0.070	
L1	2.74 BSC		0.	108 BSC	
L2	0.89	1.27	0.035	0.050	
L3	1.15	1.52	0.040	0.060	
М	-	1.00 (reference only)	=	0.039 (reference only)	

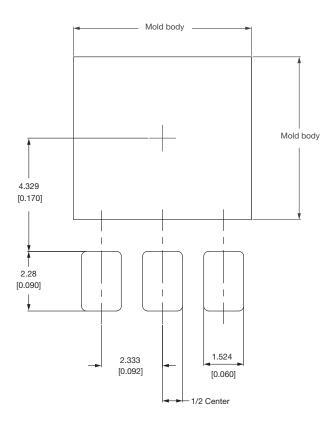
ECN: T16-0952-Rev. D, 16-Jan-17

DWG: 5894



# Recommended Land Pattern DPAK (TO-252) 3LR





### Note

• Dimensions in mm (inches)

ECN: T22-0575-Rev. A, 12-Dec-2022

DWG: 3015

Revision: 12-Dec-2022



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